



*THE INSTITUTE FOR
INTERCONNECTING
AND PACKAGING
ELECTRONIC CIRCUITS*

Printed Board Description in Digital Form

A joint standard developed by Technical Committee 52 of the International Electrotechnical Commission (IEC) and the Computerized Data Format Standardization Subcommittee (2-11) of the Data Generation and Transfer Committee (2-10) of the Institute for Interconnecting and Packaging Circuits.

This document bears two reference numbers, and may be obtained from the IPC, the IEC, or ANSI. IPC-D-350D and IEC 1182-1 are identical in technical content.

The IEC version of this document also contains a French translation. The IEC is responsible for the accuracy of that translation.

Users of this standard are encouraged to participate in the development of future revisions.

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Printed Board Description in Digital Form

1.0 SCOPE

This standard specifies record formats used to describe printed board products with detail sufficient for tooling, manufacturing and testing requirements. These formats may be used for transmitting information between a printed board designer and a manufacturing facility. The records are also useful when the manufacturing cycle includes computer-aided processes and numerically controlled machines.

The information can be used for both manual and for digital interpretation. The data may be defined in either English or SI units.

1.1 Format Compatibility The concepts detailed in this standard may be supplemented by descriptions defined in other companion IPC Standards. It is the intent that a family of standards be developed with applicability for various record formats.

Data redundancy shall be kept to a minimum by using companion standards for appropriate data descriptions, depending upon the use of the data. The following shows the correlation between standards and record formats that are to be defined:

Table 1-1 Correlation Between IPC-D-35X Standards and Record Formats

IPC-D-35X Standards	Record Description
IPC-D-350	Artwork Records
IPC-D-350	Board Description Records
IPC-D-351	Schematic Drawing Records
IPC-D-351	Master Drawing Records
IPC-D-351	Assembly Drawing Records
IPC-D-351	Miscellaneous Part Drawing Records
IPC-D-352	Electrical Description Records
IPC-D-352	Parts List Records
IPC-D-354	Library Description Records
IPC-D-356	Bare Board Electrical Test Information

2.0 APPLICABLE DOCUMENTS

The following documents of the issue currently in effect form a part of this standard to the extent specified herein.

2.1 IPC¹

IPC-T-50 Terms and Definitions

1. To obtain documents, write: IPC, 2215 Sanders Road, Northbrook, IL 60062-6135

2. To obtain documents, write: American National Standards Institute, 1430 Broadway, New York, NY 10018

3. To obtain documents, write: Standardization Documents Order Desk, Building 4D, 700 Robbins Avenue, Philadelphia, PA 19111-5094

4. To obtain documents, write: (ISO or IEC) Central Office, 3 Rue De Varembe, P.O. Box 131, 1211 Geneva 20, Switzerland

IPC-D-310 Suggested Guidelines for Artwork Generation and Measurement Techniques for Printed Circuits

IPC-D-354 Library Format Description for Printed Board Digital Data Bases

IPC-D-390 Automated Design Guidelines

2.2 American National Standards Institute²

ANSI X3/TR-1-77 American National Directory for Information Processing

ANSI X3.4 Standard Code for Information Exchange

ANSI X3.12 Subroutine Record Format Standardization

ANSI X3.22 Recorded Magnetic Tape for Information Interchange

ANSI X3.26 Hollerith Punched Card Code

ANSI X3.39 Recorded Magnetic Tape

ANSI X3.54 Recorded Magnetic Tape

ANSI Z210.1 Metric Practice Guide (ASTM E380-72)

2.3 Department of Defense³

W-T-0051 Tape, Electronic Data Processing, 1971

2.4 International Electrotechnical Commission (IEC)⁴ International Standards Organization⁴

IEC Publication 194 Terms and Definitions for Printed Circuits

ISO Publication 646 Information Processing. ISO 7-Bit Coded Character Set for Information Exchange

3.0 TERMS AND DEFINITIONS

Unless otherwise specified herein, terms and definitions shall be in accordance with IPC-T-50, IEC 194, ANSI X3.12 and the definitions in the following paragraphs. Useful terms from the referenced standards are reprinted in Appendix B and C to assist in the understanding of this document.